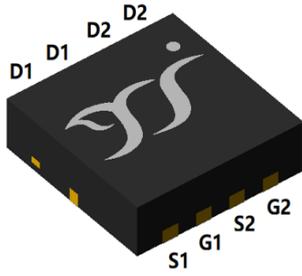
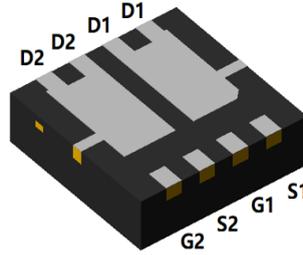


N-Channel and P-Channel Complementary Power MOSFET

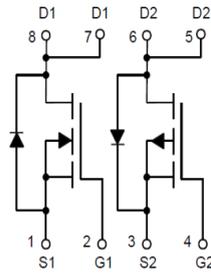


Top View



Bottom View

DFN3333-8L



Product Summary

NMOS

• V_{DS}	30V
• I_D	20A
• $R_{DS(ON)}$ (at $V_{GS}=10V$)	<30mohm
• $R_{DS(ON)}$ (at $V_{GS}=4.5V$)	<52mohm

PMOS

• V_{DS}	-30V
• I_D	-17A
• $R_{DS(ON)}$ (at $V_{GS}=-10V$)	<45mohm
• $R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	<65mohm

General Description

- Trench Power LV MOSFET technology
- High density cell design for low $R_{DS(ON)}$
- High Speed switching
- Moisture Sensitivity Level 3
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Wireless charger
- Load switch
- Power management

■ Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-source Voltage		V_{DS}	30	-30	V
Gate-source Voltage		V_{GS}	± 20	± 20	V
Drain Current	$T_A=25^\circ C$	I_D	3.6	-5	A
	$T_A=70^\circ C$		2.9	-4	
	$T_C=25^\circ C$		20	-17	
	$T_C=70^\circ C$		16	-13	
Pulsed Drain Current ^A		I_{DM}	15	-20	A
Total Power Dissipation	$T_A=25^\circ C$	P_D	2	2	W
	$T_A=70^\circ C$		1.3	1.3	W
	$T_C=25^\circ C$		25	22	
	$T_C=70^\circ C$		16	14	
Thermal Resistance Junction-to-Ambient ^B		$R_{\theta JA}$	62.5	62.5	$^\circ C/W$
Thermal Resistance Junction-to-Case		$R_{\theta JC}$	5	5.5	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	-55~+150	$^\circ C$

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJQ3611A	F1	Q3611	5000	10000	100000	13" reel



YJQ3611A

■ N-MOS Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=30V, V_{GS}=0V$			1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1	1.5	2.2	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=3.6A$		23	30	m Ω
		$V_{GS}=4.5V, I_D=3A$		40	52	
Diode Forward Voltage	V_{SD}	$I_S=3.6A, V_{GS}=0V$			1.2	V
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{DS}=15V, V_{GS}=0V, f=1\text{MHZ}$		314		pF
Output Capacitance	C_{oss}			59		
Reverse Transfer Capacitance	C_{rss}			48		
Switching Parameters						
Total Gate Charge	Q_g	$V_{GS}=10V, V_{DS}=15V, I_D=2A$		6.08		nC
Gate-Source Charge	Q_{gs}			1.26		
Gate-Drain Charge	Q_{gd}			1.32		
Reverse Recovery Charge	Q_{rr}	$I_F=3.6A, di/dt=100A/\mu s$		1.66		ns
Reverse Recovery Time	t_{rr}			17.33		
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=10V, V_{DS}=15V, R_L=4.1\Omega$ $R_{GEN}=3\Omega$		3.8		ns
Turn-on Rise Time	t_r			23.2		
Turn-off Delay Time	$t_{D(off)}$			7		
Turn-off fall Time	t_f			18.6		

A. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

B. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



YJQ3611A

■ P-MOS Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-30			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-30V, V_{GS}=0V$			-1	μA
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-1	-1.5	-2.4	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-4.1A$		35	45	m Ω
		$V_{GS}=-4.5V, I_D=-3.5A$		49	65	
Diode Forward Voltage	V_{SD}	$I_S=-4.1A, V_{GS}=0V$			-1.2	V
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{DS}=-15V, V_{GS}=0V, f=1\text{MHz}$		719		pF
Output Capacitance	C_{oss}			78		
Reverse Transfer Capacitance	C_{rss}			64		
Switching Parameters						
Total Gate Charge	Q_g	$V_{GS}=-10V, V_{DS}=-15V, I_D=-5.1A$		14.23		nC
Gate-Source Charge	Q_{gs}			3.16		
Gate-Drain Charge	Q_{gd}			2		
Reverse Recovery Charge	Q_{rr}	$I_F=-5.1A, di/dt=100A/\mu s$		5.3		ns
Reverse Recovery Time	t_{rr}			30		
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=-10V, V_{DS}=-15V, I_D=5.1A$ $R_{GEN}=3\Omega$		7.4		ns
Turn-on Rise Time	t_r			37		
Turn-off Delay Time	$t_{D(off)}$			31.6		
Turn-off fall Time	t_f			42		

C. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

D. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in 2 pad of 2oz copper.



■ N-MOS Typical Performance Characteristics

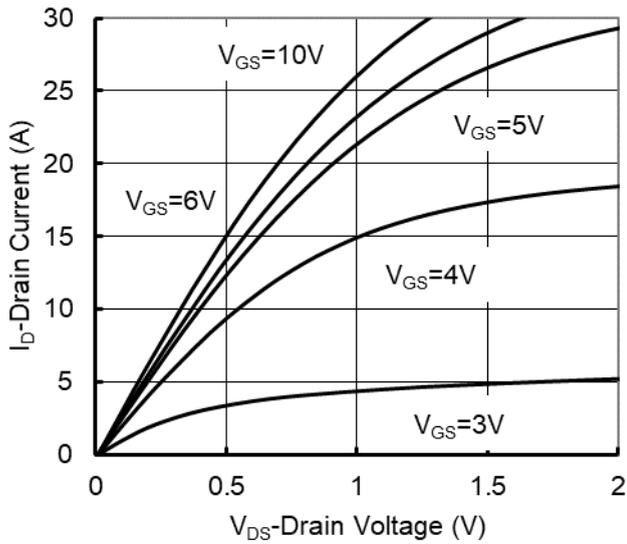


Figure1. Output Characteristics

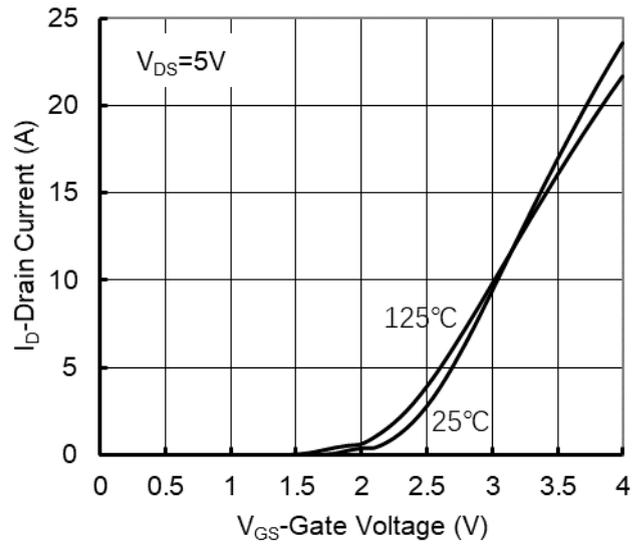


Figure2. Transfer Characteristics

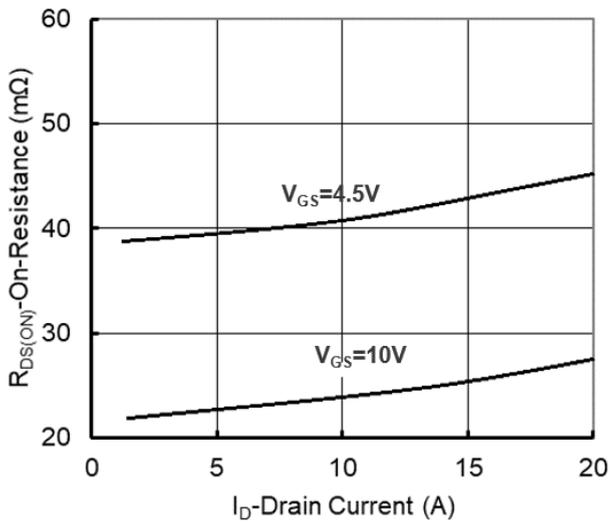


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

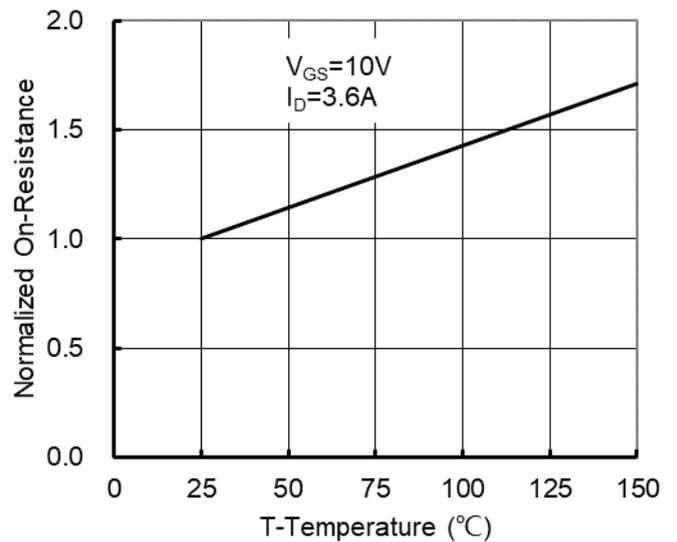


Figure 4: On-Resistance vs. Junction Temperature

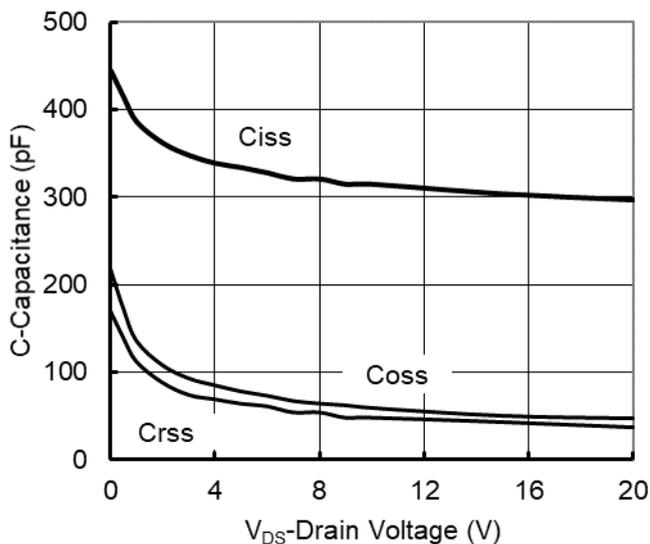


Figure5. Capacitance Characteristics

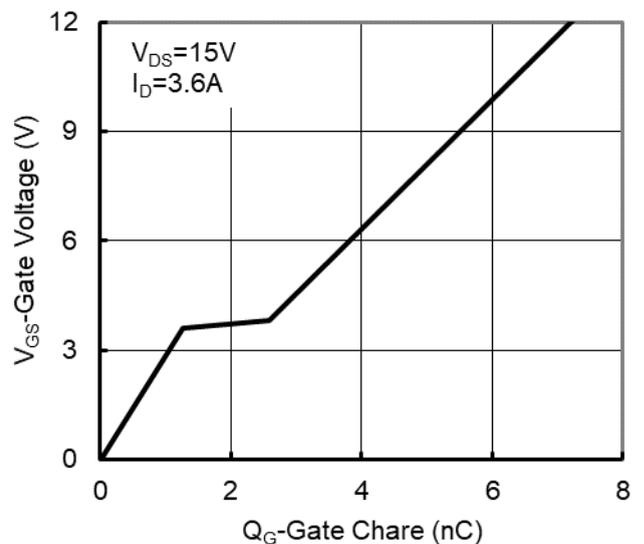


Figure6. Gate Charge



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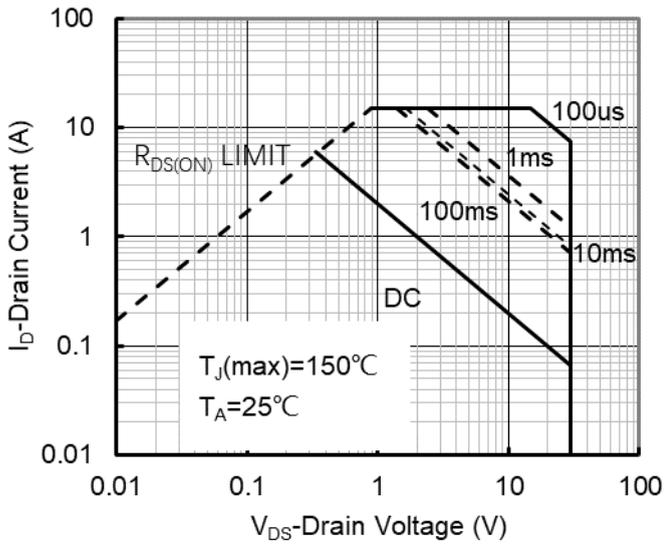


Figure7. Safe Operation Area

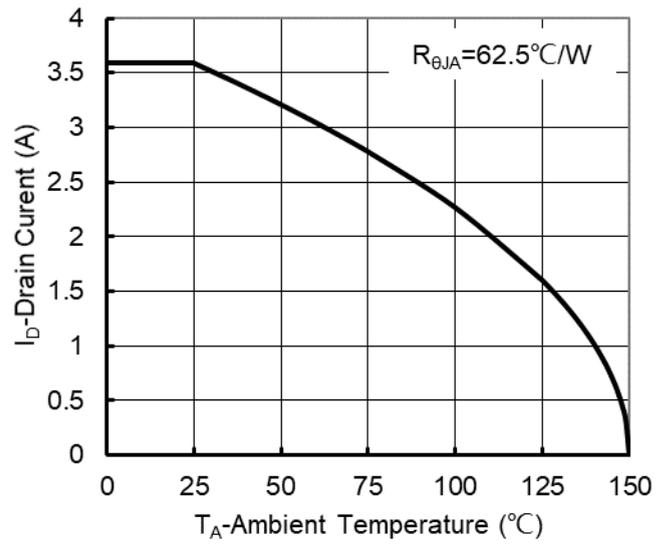


Figure8. Maximum Continuous Drain Current vs Ambient Temperature

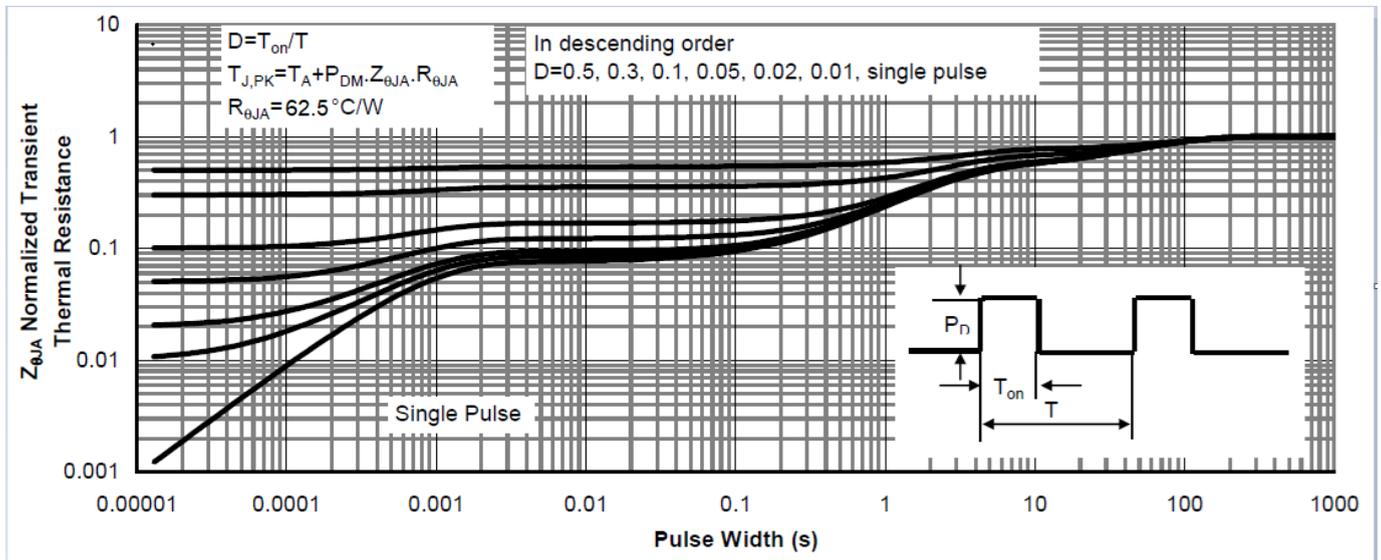


Figure9. Normalized Maximum Transient Thermal Impedance



■ P-MOS Typical Performance Characteristics

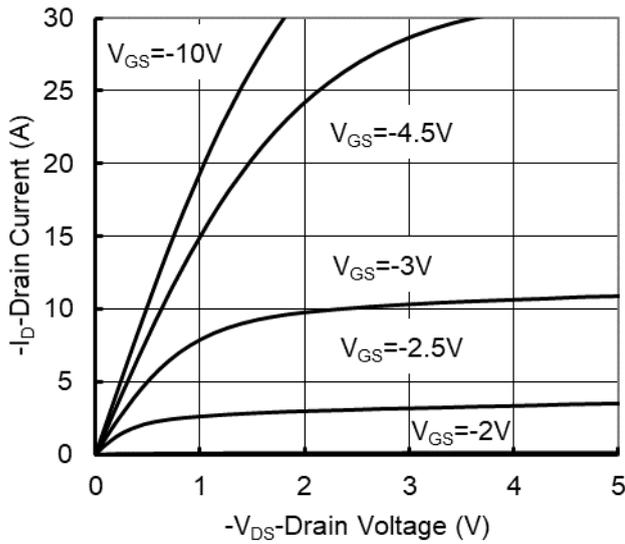


Figure1. Output Characteristics

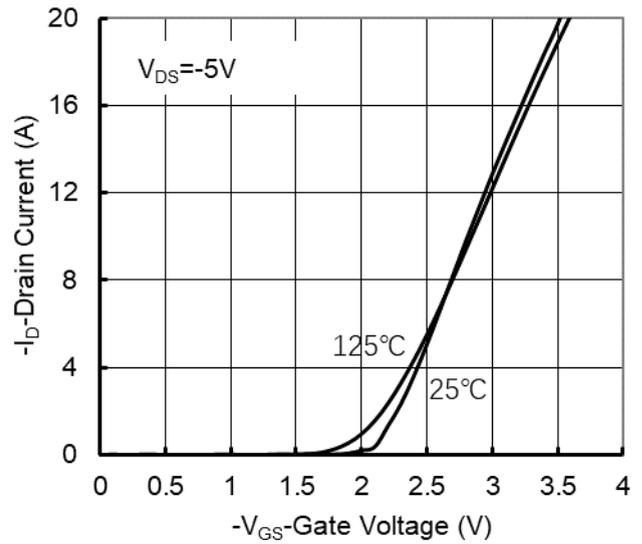


Figure2. Transfer Characteristics

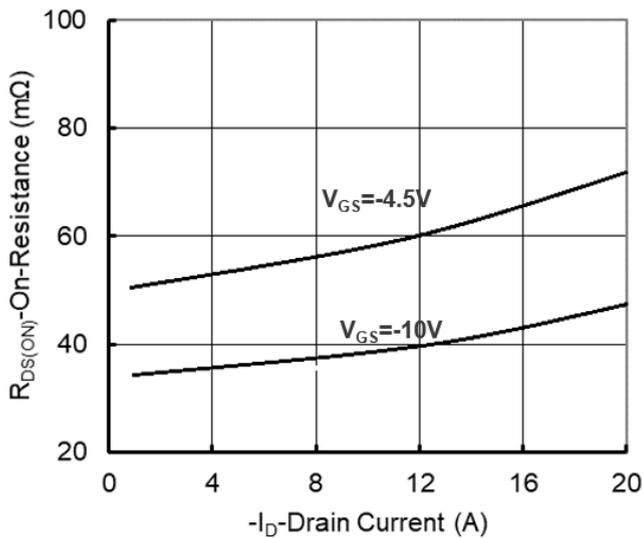


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

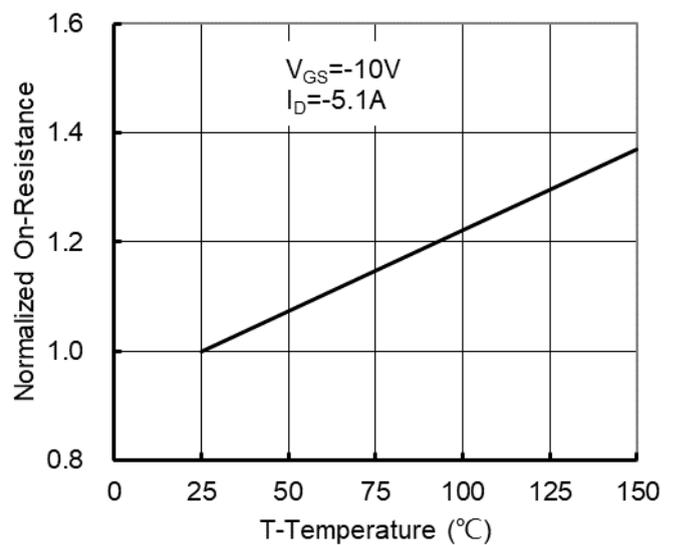


Figure 4: On-Resistance vs. Junction Temperature

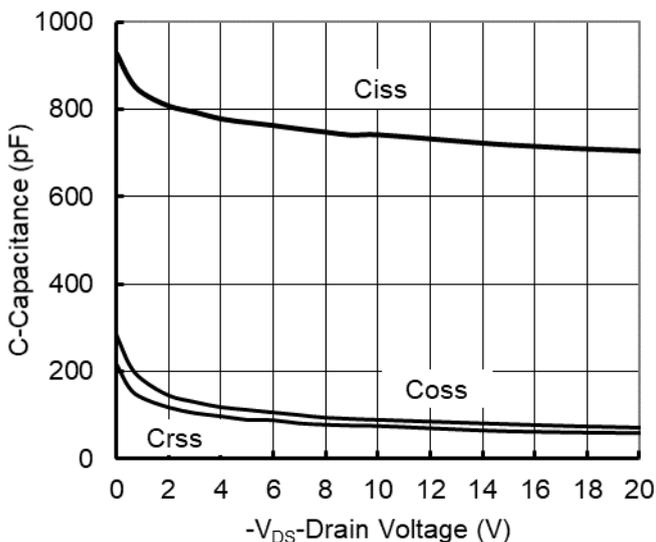


Figure5. Capacitance Characteristics

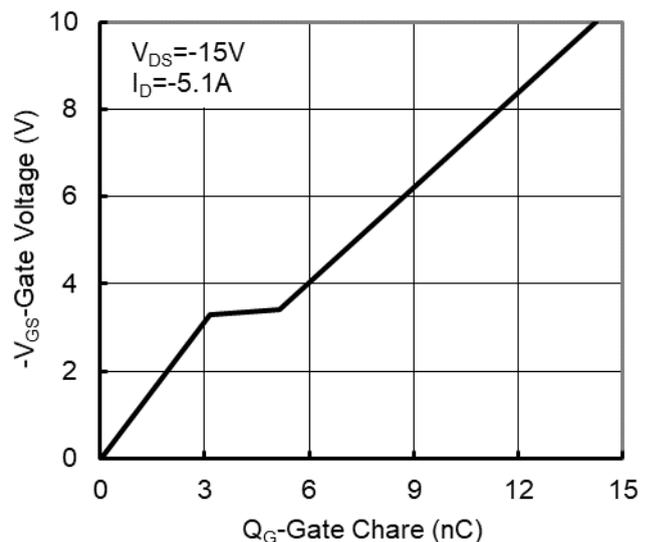


Figure6. Gate Charge



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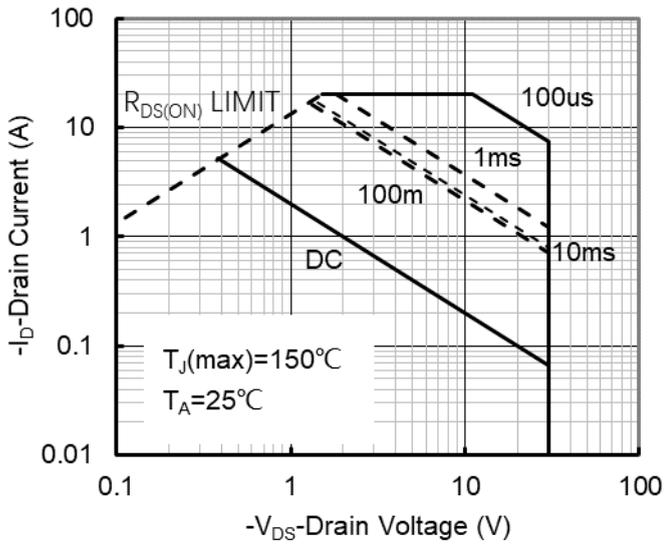


Figure7. Safe Operation Area

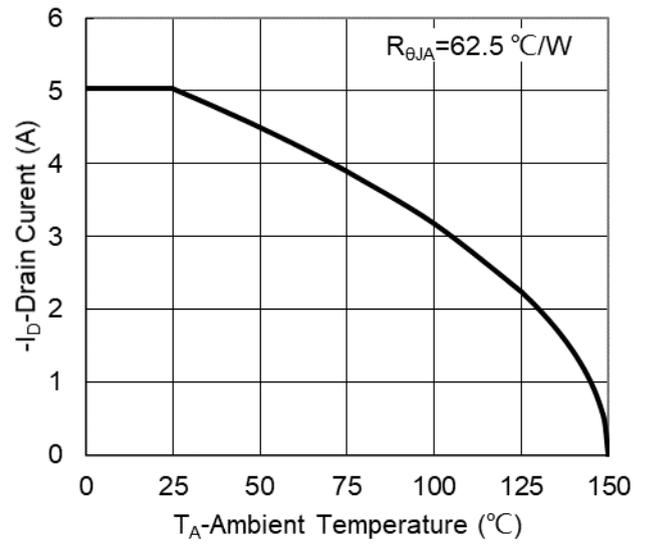


Figure8. Maximum Continuous Drain Current vs Ambient Temperature

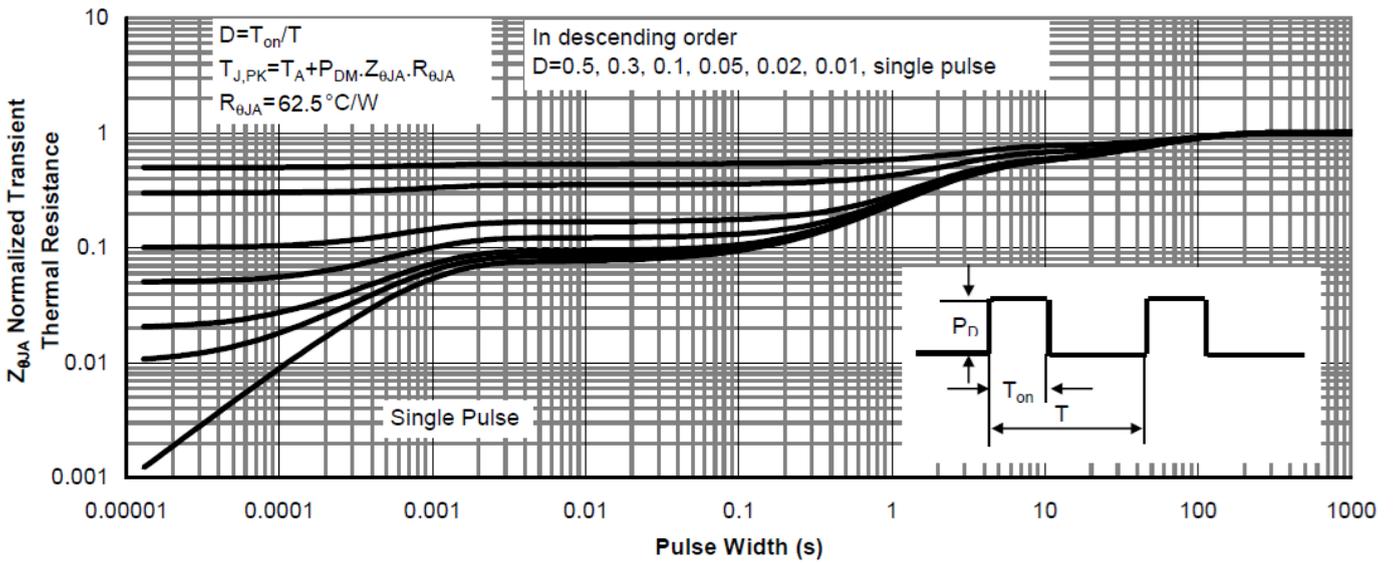
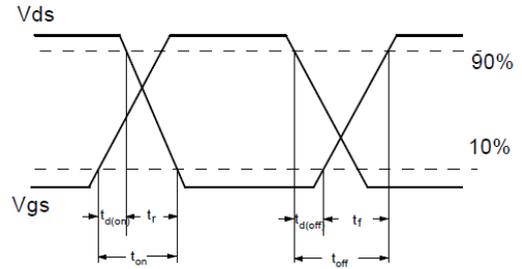
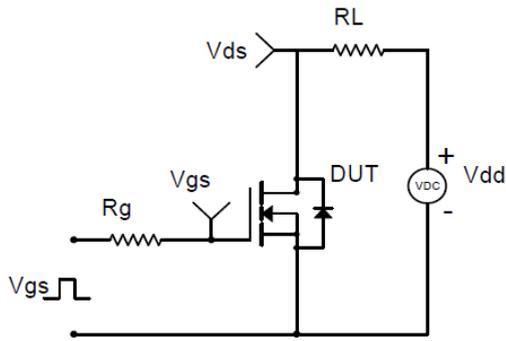
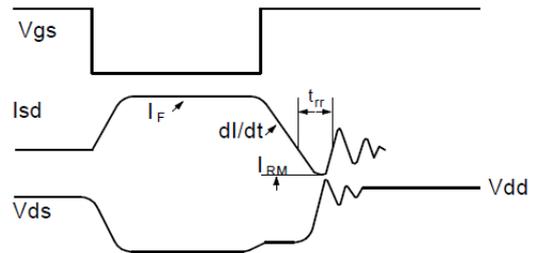
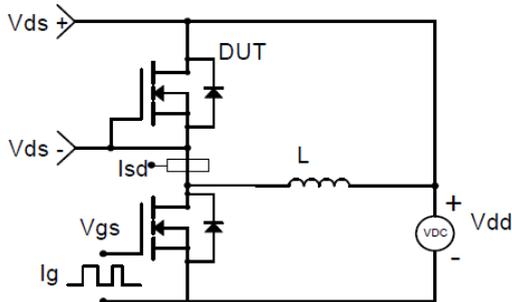


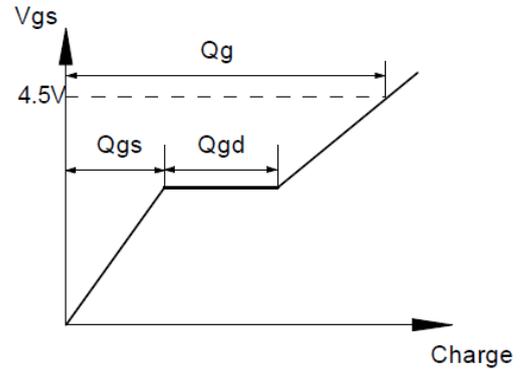
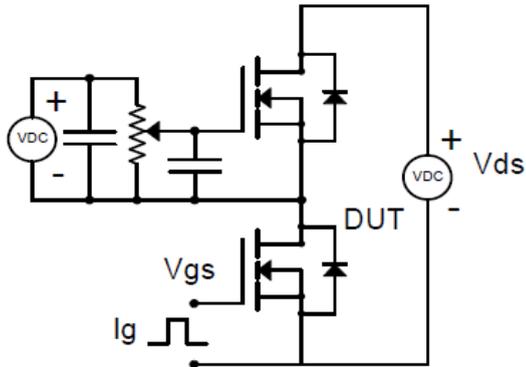
Figure9. Normalized Maximum Transient Thermal Impedance



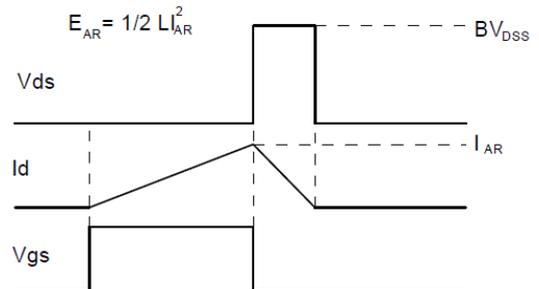
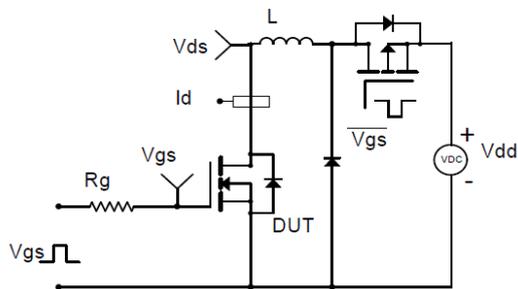
Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Gate Charge Test Circuit & Waveform

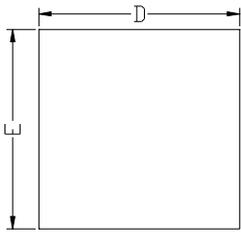


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

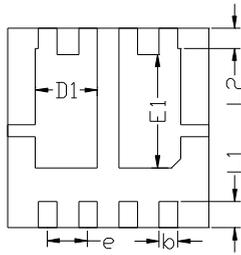


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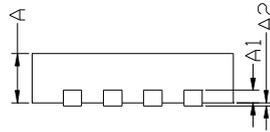
■ DFN3333-8L Package Information



Top View
正面视图

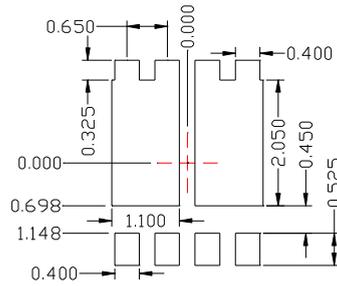


Bottom View
背面视图



Side View
侧面视图

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	3.15	3.25	3.35
E	3.15	3.25	3.35
A	0.70	0.80	0.90
A1	0.20 BSC		
A2			0.10
D1	0.90	1.00	1.10
E1	1.75	1.85	1.95
L1	0.325	0.425	0.525
L2	0.325 BSC		
b	0.20	0.30	0.40
e	0.65 BSC		



Suggested Solder Pad Layout
Top View

Note:

1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.10\text{mm}$.
3. The pad layout is for reference purposes only.



YJQ3611A

Disclaimer

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